CUI DEVICES

date 06/25/2021

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MODEL: HSS10-B20-P40 | DESCRIPTION: HEAT SINK

FEATURES

- TO-220 package
- solder pin
- aluminum alloy
- black anodized finish





thermal resistance¹ power dissipation¹ @ 1 W, @ 1 W, 400 LFM @ 75°C ∆T, @ 75°C ∆T, @ 1 W, 200 LFM nat conv nat conv nat conv (°C/W) (°C/W) (°C/W) (°C/W) (W) 7.9 HSS10-B20-P40 21.9 6.1 4.14 18.12

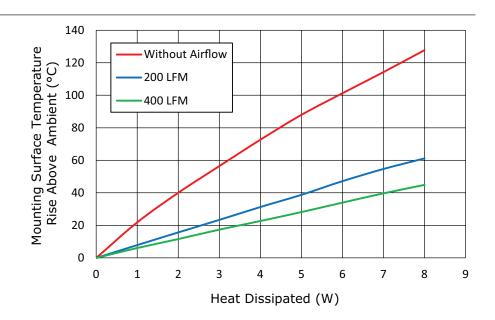
Note: 1. See performance curves for full thermal resistance details.

PERFORMANCE CURVES

	Heatsink Temperature Rise Above Ambient (ΔT = Ths - Ta) (°C)			
Power (W)	Natural Conv.	200 LFM	400 LFM	
0	0	0	0	
1	21.9	7.9	6.1	
2	40.1	15.7	11.6	
3	56.5	23.4	17.4	
4	72.7	31.3	22.7	
5	88.0	38.8	28.2	
6	101.3	47.2	34.0	
7	114.3	54.7	39.7	
8	127.3	61.2	44.9	

Ths: "hot spot" temperature measured on the heatsink

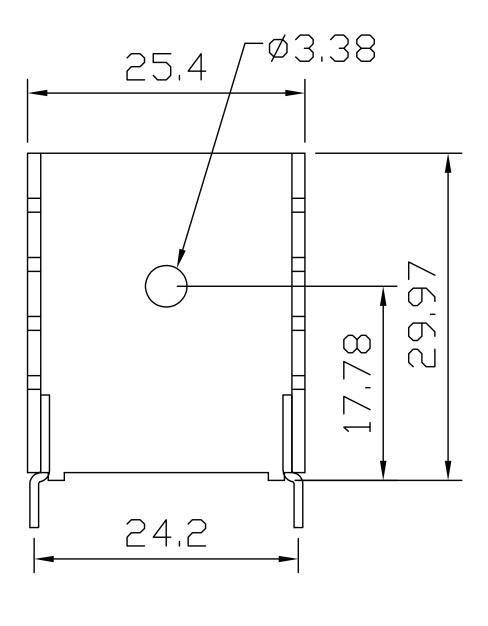
Ta: ambient temperature

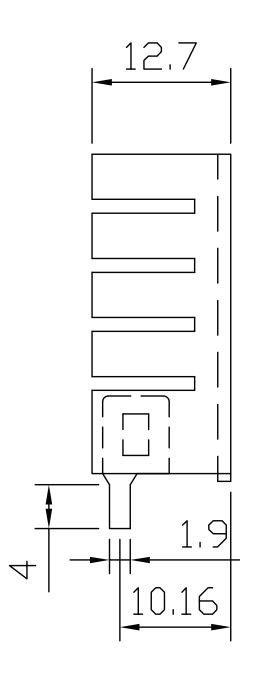


MECHANICAL DRAWING

units: mm tolerance: ±0.25 mm

MATERIAL	AL 1050
FINISH	black anodized
THICKNESS	1.2 mm
PIN MATERIAL	brass
PIN PLATING	2~3 μm tin
WEIGHT	5.0 g





Additional Resources: Product Page

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REVISION HISTORY

rev.	description	date
1.0	initial release	06/25/2021

The revision history provided is for informational purposes only and is believed to be accurate.

CUI DEVICES

CUI Devices offers a one (1) year limited warranty. Complete warranty information is listed on our website.

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